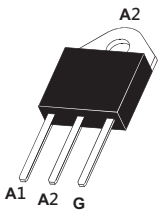
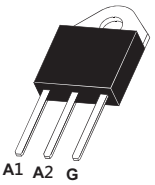
TRIACs, 40A
Sunbberless

FEATURES

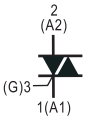
- High current triac
- Low thermal resistance with clip bonding
- Low thermal resistance insulation ceramic for insulated TO-3P package
- High commutation capability
- 41T series are **UL** certified (File ref: E320098)
- Packages are RoHS compliant



TO-3P (**non-Insulated**)
(41TxxB)



TO-3P (**Insulated**)
(41TxxBI)



APPLICATIONS

The snubberless concept offer suppression of RC network and it is suitable for applications such as on/off function in static relays, heating regulation, induction motor starting circuits, phase control operation in light dimmers, motor speed controllers, and silmilar.

Due to their clip assembly techinque, they provide a superior performance in surge current handling capabilities.

By using an internal ceramic pad, the 41T series provides voltage insulated tab (rated at 2500V_{RMS}) complying with UL standards.

MAIN FEATURES

SYMBOL	VALUE	UNIT
$I_{T(RMS)}$	40	A
V_{DRM}/V_{RRM}	600 to 1600	V
$I_{GT(Q1)}$	35 to 50	mA

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS		VALUE	UNIT
RMS on-state current (full sine wave)	$I_{T(RMS)}$	TO-3P	T_c = 95ºC	40	A
		TO-3P insulated	T_c = 80ºC		
Non repetitive surge peak on-state current (full cycle, T_j initial = 25°C)	I_{TSM}	F =50 Hz	t = 20 ms	400	A
		F =60 Hz	t = 16.7 ms	420	
I^2t Value for fusing	I^2t	t_p = 10 ms		800	A^2s
Critical rate of rise of on-state current $I_G = 2xI_{GT}$, $t_r \leq 100ns$	dI/dt	F =100 Hz	T_j =125°C	50	A/µs
Peak gate current	I_{GM}	T_p =20 µs	T_j =125°C	4	A
Peak gate power dissipation (tp = 20µs)	P_{GM}	T_j =125°C		10	W
Average gate power dissipation	$P_{G(AV)}$	T_j =125°C		1	
Storage temperature range	T_{stg}			- 40 to + 150	ºC
Operating junction temperature range	T_j			- 40 to + 125	

◎ ELECTRICAL CHARACTERISTICS (T_J= 25 ºC unless otherwise specified)

SNUBBERLESS and Logic level (3 quadrants)

SYMBOL	TEST CONDITIONS	QUADRANT		41Txxxx	Unit
				BW	
I_{GT}(1)	V_D = 12 V, R_L = 30Ω	I - II - III	MAX.	50	mA
V_{GT}		I - II - III		1.3	V
V_{GD}	V_D = V_{DRM}, R_L = 3.3KΩ T_j = 125°C	I - II - III	MIN.	0.2	V
I_H(2)	I_T = 500 mA		MAX.	60	mA
I_L	I_G = 1.2 I_{GT}	I - III	MAX.	80	mA
		II		100	
dV/dt(2)	V_D = 67% V_{DRM}, gate open ,T_j = 125°C		MIN.	1000	V/µs
(dI/dt)c(2)	Without snubber, T_j = 125°C			20	A/ms

STATIC CHARACTERISTICS

SYMBOL	TEST CONDITIONS			VALUE	UNIT
V_{TM}(2)	I_{TM} = 60 A, t_P = 380 µs	T_j = 25°C	MAX.	1.55	V
V_{t0}(2)	Threshold voltage	T_j = 125°C	MAX.	0.85	V
R_d(2)	Dynamic resistance	T_j = 125°C	MAX.	10	mΩ
I_{DRM} I_{RRM}	V_D = V_{DRM} V_R = V_{RRM}	T_j = 25°C	MAX.	10	µA
		T_j = 125°C		5	mA

Note 1: Minimum I_{GT} is guaranted at 5% of I_{GT} max.
Note 2: For both polarities of A2 referenced to A1.

THERMAL RESISTANCE

SYMBOL			VALUE	UNIT
$R_{th(j-c)}$	Junction to case (AC)	TO-3P	0.6	°C/W
		TO-3P Insulated	0.9	
$R_{th(j-a)}$	Junction to ambient	TO-3P, TO-3P Insulated	50	

S = Copper surface under tab.

PRODUCT SELECTOR

PART NUMBER	VOLTAGE (xx)					SENSITIVITY	TYPE	PACKAGE
	600 V	800 V	1000 V	1200 V	1600 V			
41TxxB-BW/41TxxBI-BW	V	V	V	V	V	50 mA	Snubberless	TO-3P

BI: Insulated TO-3P package

ORDERING INFORMATION

ORDERING TYPE	MARKING	PACKAGE	WEIGHT	BASE Q'TY	DELIVERY MODE
41TxxB-yy	41TxxB-yy	TO-3P	4.3g	30	Tube
41TxxBI-yy	41TxxBI-yy	TO-3P insulated	4.8g	30	Tube

Note: xx = voltage, yy = sensitivity

ORDERING INFORMATION SCHEME

41 T 06 B - BW

Current
41 = 40A

Triac series

Voltage
06 = 600V
08 = 800V
10 = 1000V
12 = 1200V
16 = 1600V

Package type
B = TO-3P (non-insulated)
BI = TO-3P (insulated)

I_{GT} Sensitivity
BW = 50mA Snubberless

Fig.1 Maximum power dissipation versus on-state rms current (full cycle)

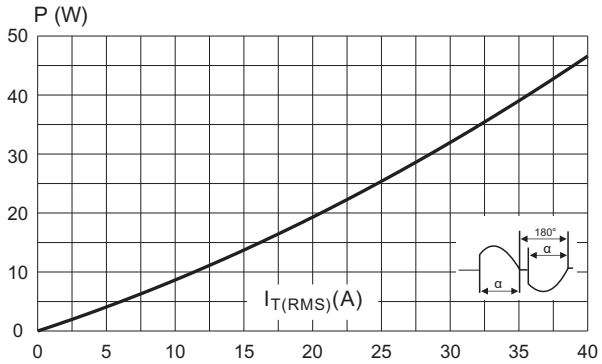


Fig.2 On-state rms current versus case temperature (full cycle)

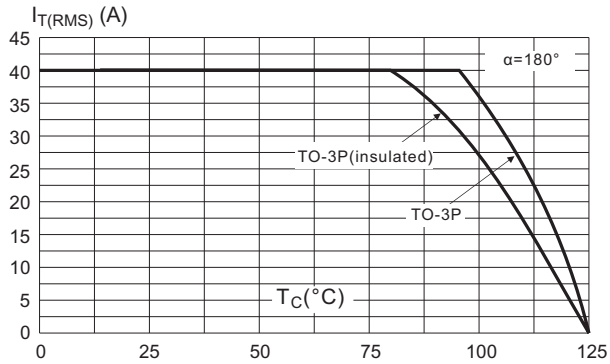


Fig.3 Relative variation of thermal impedance versus pulse duration.

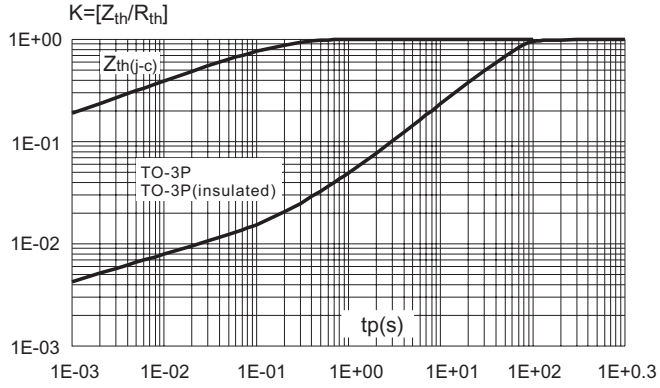


Fig.4 On-state characteristics (maximum values).

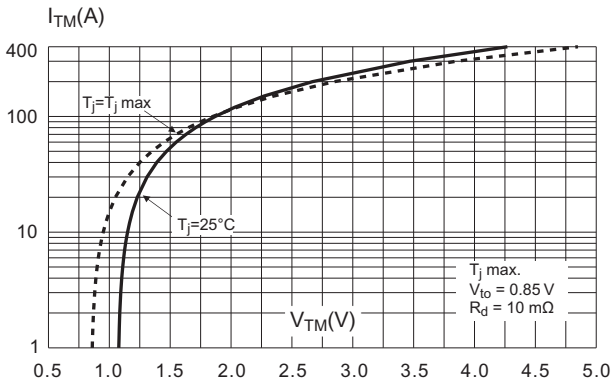


Fig.5 Surge peak on-state current versus number of cycles.

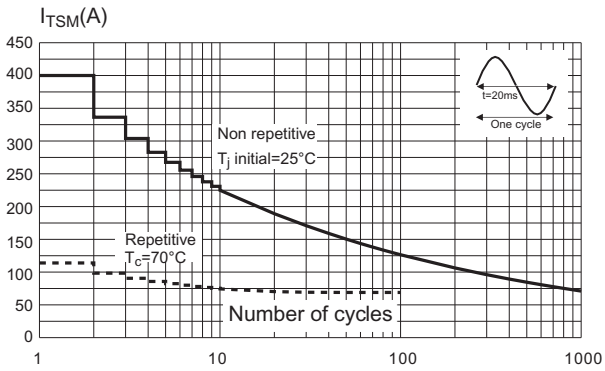


Fig.6 Non-repetitive surge peak on-state current for a sinusoidal pulse and corresponding value of I^2t.

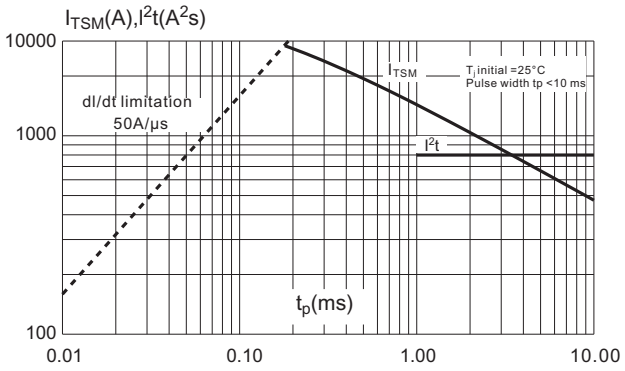


Fig.7 Relative variation of gate trigger, holding and latching current versus junction temperature.

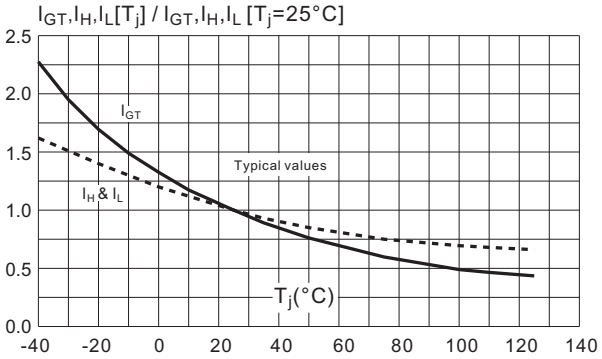


Fig.8 Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values).

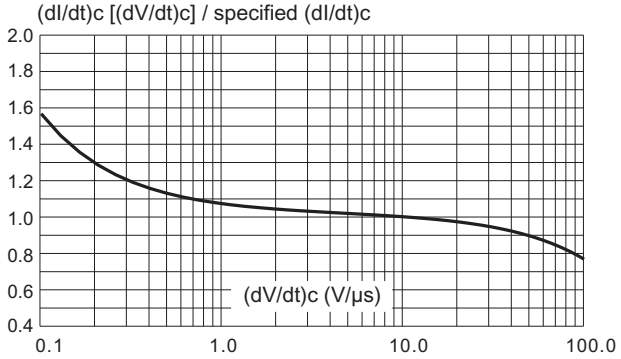
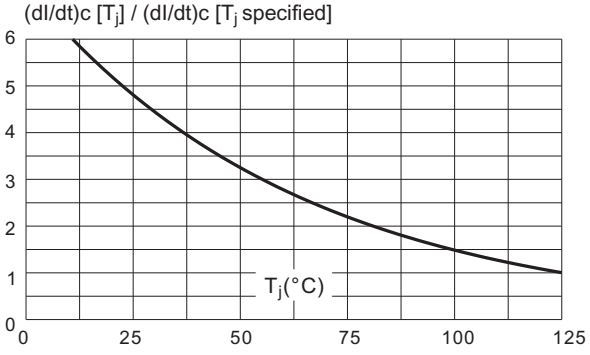
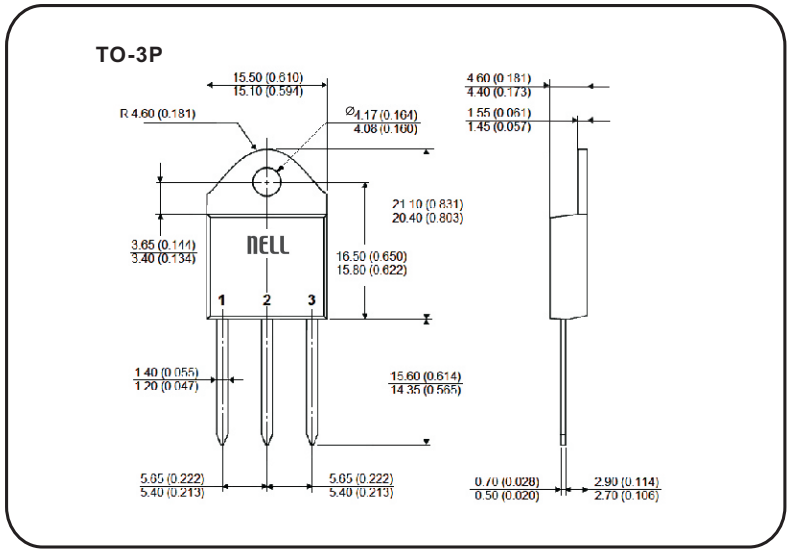


Fig.9 Relative variation of critical rate of decrease of main current versus (dV/dt)c.



Case Style



All dimensions in millimeters(inches)

